Overview

HP 250 G7 Notebook PC



- 1. Webcam LED
- 2. Webcam
- 3. Internal microphone
- 4. Touchpad
- 5. Touchpad button
- 6. Audio combo jack

Left

- 7. USB 3.1 Gen 1 port
- 8. USB 3.1 Gen 1 port
- 9. HDMI port (Cable not included)
- 10. RJ-45/Ethernet port
- 11. AC Smart Pin adapter plug
- 12. Power button

Overview



- 1. Security lock slot (Lock sold separately)
- 2. Optical drive (optional)
- 3. USB 2.0 port

Right

- 4. SD Card slot
- 5. Hard drive indicator LED
- 6. Power indicator LED

Overview

AT A GLANCE

- Preinstalled with Windows 10 versions or FreeDOS
- Choice of 10th or 8th Generation Intel® Core™ processors
- 15.6" (39.6 cm) diagonal FHD/HD Anti-Glare Display
- Choice of Integrated Intel® UHD Graphics 620, Intel® HD Graphics 620, Intel® UHD Graphics 605, Intel® UHD Graphics 600 or Switchable Discrete Graphics NVIDIA Geforce MX130, NVIDIA Geforce MX110
- Dark Ash Silver or Asteroid Silver color with texture pattern (Color options available in select countries)
- Up to 1 TB Hard Drive or 512 GB M.2 PCIe Value Solid State Drive
- Weight starting at 1.78 Kgs (3.91 lbs)
- Security features including FW TPM 2.0 and security lock slot (Lock not included)
- Keyboard Full size textured island-style keyboard with numeric pad
- Touchpad with gestures support
- HP webcam with single digital microphone and HD (supporting WDR- Wide Dynamic Range) or VGA camera
- Two USB 3.1 (Gen 1) ports and One USB 2.0 port
- Wireless LAN (WLAN) up to 802.11ac to keep you connected
- Battery Life Up to 12 hours and 30 minutes

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

PRODUCT NAME

HP 250 G7 Notebook PC

OPERATING SYSTEM

Preinstalled Windows 10 Pro 64¹

Windows 10 Home 641

Windows 10 Home Single Language 64¹ Windows 10 Pro 64 (National Academic only)²

FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com/.

2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

PROCESSOR

Intel® Core™ i3-10110U Processor with Intel® UHD Graphics 620 (2.1 GHz base frequency, up to 4.1 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 2 cores) 3,4,5,6

Intel® Core™ i5-10210U Processor with Intel® UHD Graphics 620 (1.6 GHz base frequency, up to 4.2 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores) 3,4,5,6

Intel® Core™ i7-10510U Processor with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.9 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores) ^{3,4,5,6}

Intel® Core™ i3- 8130U processor with Intel® HD Graphics 620 (2.2 GHz base frequency, up to 3.4 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 4 cores)^{3,4,5,6}

Intel® Core™ i3+ 8130U processor (Core™ i3 and 16 GB Intel® Optane™ memory) with Intel® HD Graphics 620 (2.2 GHz base frequency, up to 3.4 GHz with Intel® Turbo Boost Technology, 4 MB L3 cache, 4 cores)^{3,4,5,6,7}

Intel® Pentium® Gold Processor 4417U with Intel® HD Graphics 610 (2.3 GHz base frequency, 2 MB cache, 2 cores)^{3,4,6} Intel® Pentium® Silver Processor N5030 with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 3.1 GHz burst frequency, 4 MB cache, 4 cores)^{3,4,6}

Intel® Celeron® Processor N4020 with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.8 GHz burst frequency, 4 MB cache, 2 cores)^{3,4,6}

Intel® Core™ i7-8565U processor with Intel® UHD Graphics 620 (1.8 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6,31}

Intel® Core™ i5-8265U with Intel® UHD Graphics 620 Graphics (1.6 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores) ^{3,4,5,6,31}

Intel® Core™ i3-7020U with Intel® HD Graphics 620 (2.3 GHz, 3 MB cache, 2 cores)^{3,4,6,31}

Intel® Pentium® Silver Processor N5000 with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 2.7 GHz burst frequency, 4 MB cache, 4 cores)^{3,4,6,31}

Intel® Celeron® Processor N4000 with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.6 GHz burst frequency, 4 MB cache, 2 cores)^{3,4,6,31}

Intel® Core™ i7+ 8565U processor (Core™ i7 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (4.1 GHz base frequency, up to 4.6 GHz with Intel® Turbo Boost Technology, 8 MB L3 cache, 4 cores)^{3,4,5,6,7,31}

Intel® Core™ i5+ 8265U processor (Core™ i5 and 16 GB Intel® Optane™ memory) with Intel® UHD Graphics 620 (3.7 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology, 6 MB L3 cache, 4 cores)^{3,4,5,6,7,31}

Intel® Celeron® N3060 with Intel® HD Graphics 400 (1.6 GHz base frequency, up to 2.48 GHz burst frequency, 2 MB cache, 2 cores)^{3,4,6,31}



Features

Intel® Core™ i3-7100U with Intel® HD Graphics 620 (2.4 GHz, 3 MB cache, 2 cores)^{3,4,6,31}

Processor Family

10th Generation Intel® Core™ i7 processor (i7-1065G7)6
10th Generation Intel® Core™ i5 processor (i5-1035G1)6
10th Generation Intel® Core™ i3 processor (i5-1005G1)6
8th Generation Intel® Core™ i3 processor (i3-8130U)6
Intel® Pentium® processor (N5030, 4417U)6
Intel® Celeron® processor (N4020)6

8th Generation Intel® Core™ i7 processor (i7-8565U)^{6,31}
8th Generation Intel® Core™ i5 processor (i5-8265U)^{6,31}
7th Generation Intel® Core™ i3 processor (i3-7020U)^{6,31}
Intel® Pentium® processor (N5000 are Windows 10 only)^{6,31}
Intel® Celeron® processor (N4000, N3060 are Windows 10 only)^{6,31}

- 3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering is not a measurement of higher performance.
- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
- 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.
- 7. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system and requires configuration with an optional Intel® Core™ i(5 or 7)+ processor.
- 31. Not available after Sep 1, 2020.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® Plus graphics^{8,9,33} Intel® UHD Graphics 620^{8,9} Intel® UHD Graphics 605^{8,9} Intel® UHD Graphics 600^{8,9} Intel® HD Graphics 620^{8,9}

Intel® HD Graphics 610^{8,9,31} Intel® HD Graphics 400^{8,9,31}



Features

Discrete

NVIDIA® GeForce® MX130 (2 GB DDR5 dedicated)9 NVIDIA® GeForce® MX110 (2 GB DDR5 dedicated)9

Supports

Support HD decode, DX12, HDMI 1.4b

- 8. HD content required to view HD images.
- 9. Integrated graphics depends on processor. NVIDIA® Optimus™ technology requires an Intel processor, plus an NVIDIA® GeForce® discrete graphics configuration and is available on Windows 10 Pro OS. With NVIDIA® Optimus™ technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).
- 31. Not available after Sep 1, 2020.
- 33. Intel® Iris® Xe Graphics capabilities require system to be configured with Intel® Core™ i5 or i7 processors and dual channel memory. Intel® Iris® Xe Graphics with Intel® Core™ i5 or 7 processors and single channel memory will only function as UHD graphics.

DISPLAY

Internal

Non-Touch

39.6 cm (15.6") diagonal HD SVA eDP anti-glare WLED-backlit slim, 220 cd/m², 67% sRGB (1366 x 768)^{8, 10,11} 39.6 cm (15.6") diagonal FHD SVA eDP anti-glare WLED-backlit slim, 220 cd/m², 67% sRGB (1920 x 1080)^{8,10,11}

HDMI

Port supports resolutions up to 1920 x 1200 external resolution @60 Hz

- 8. HD content required to view HD images.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.
- 11. Sold separately or as an optional feature.

STORAGE AND DRIVES

Primary Storage

1 TB 5400 rpm SATA¹² 500 GB 7200 rpm SATA¹² 500 GB 5400 rpm SATA¹²

Primary M.2 Storage

128 GB SATA-3 TLC Solid State Drive¹²
256 GB SATA-3 TLC Solid State Drive¹²
256 GB PCIe Gen3x4 NVMe Value Solid State Drive¹²
512 GB PCIe Gen3x4 NVMe Value Solid State Drive¹²
16 GB Intel® Optane™ Memory Cache⁷

12. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 7. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system and requires configuration with an optional Intel® Core™ (i3, i5 or i7)+ processor.



Features

MEMORY

Standard Maximum Memory

16 GB DDR4-2666 SDRAM¹⁴ 16 GB DDR4-2400 SDRAM¹⁴ 8 GB DDR4-2133 SDRAM^{14,31}

Memory

16 GB DDR4-2666 SDRAM (2 X 8 GB) ¹⁴
8 GB DDR4-2666 SDRAM (2 X 4 GB) ¹⁴
8 GB DDR4-2666 SDRAM (1 X 8 GB)
4 GB DDR4-2666 SDRAM (1 X 4 GB)
16 GB DDR4-2400 SDRAM (2 X 8 GB) ¹⁴
12 GB DDR4-2400 SDRAM (1 X 8 GB +1 X 4 GB) ^{14,32}
8 GB DDR4-2400 SDRAM (1 X 8 GB) ¹⁴
8 GB DDR4-2400 SDRAM (1 X 8 GB)
4 GB DDR4-2400 SDRAM (1 X 8 GB)
8 GB DDR4-2133 SDRAM (1 X 4 GB)
8 GB DDR4-2133 SDRAM (2 X 4 GB) ^{14,31}
4 GB DDR4-2133 SDRAM (1 X 4 GB)
4 GB DDR3L-1600 SDRAM (1 X 4 GB)
8 GB DDR3L-1600 SDRAM (1 X 8 GB) ³¹
8 GB DDR3L-1600 SDRAM (1 X 8 GB) ³¹

Memory Slots

2 SODIMM (Intel® 10th, 8th & 7th Generation Intel® Core™ processor)
DDR4 PC4 SODIMMS, system runs at 2666 or 2400
DDR4 PC4 SODIMMS, system runs at 2133 (Intel 7th Gen- Kaby Lake)³¹
Supports Dual Channel Memory¹³
Both slots are customer non-accessible / non-upgradeable

Memory Slots

1 SODIMM (Intel® N5030, N4020 processor) Single Channel Memory Memory slot are customer non-accessible / non-upgradeable

Memory Slots

1 SODIMM (Intel® N5000, N4000 processor) ³¹ Single Channel Memory Memory slot are customer non-accessible / non-upgradeable

Memory Slots

1 SODIMM (Intel® N3060 processor) ³¹ Single Channel Memory

Memory slot are customer non-accessible / non-upgradeable

- 13. Dual channel memory support only for 10th, 8th and 7th Generation Intel® Core™ processors.
- 14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.
- 31. Not available after Sep 1, 2020.
- 32. Only available to Intel® Core™ i3- 8130U processor and Intel® Pentium® Gold Processor 4417U



Features

NETWORKING/COMMUNICATIONS

Wireless LAN (WLAN)

Realtek 802.11ac (2x2) Wi-Fi® and Bluetooth® 5.0 Combo (MU-MIMO supported)¹⁵ Realtek 802.11ac (2x2) Wi-Fi® and Bluetooth® 4.2 Combo (MU-MIMO supported)¹⁵

Realtek 802.11ac (1x1) and Bluetooth® 4.2 Combo¹⁵

Realtek 802.11b/g/n (1x1) and Bluetooth® 4.2 Combo 15,31

Miracast

Compatible with Miracast-certified devices¹⁶

Ethernet

Integrated 10/100/1000 GbE NIC

- 15. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.
- 16. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.
- 31. Not available after Sep 1, 2020.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers

Camera

HP TrueVision HD Camera^{8,11}

Webcam

VGA webcam^{11,17}

Optical Drive

Optional DVD-Writer18,19

- 8. HD content required to view HD images.
- 11. Sold separately or as an optional feature.
- 17. Internet access required.
- 18. Unit shipped with either "DVD+/-RW SuperMulti DL" or "DVD Writer Drive." Units undergoing repairs may be returned with a "DVD+/-RW SuperMulti DL."
- 19. HD-DVD disks cannot be played on this drive. No support for DVDRAM. Actual speeds may vary. Don't copy copyright protected materials. Double Layer discs can store more data than single layer discs; discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Kevhoard

Keyboard - Full size textured island-style keyboard with numeric pad

Pointing Device

Touchpad with multi-touch gesture support

Function Keys

F1 - Open " How to get help in Windows 10" webpage



Features

F2 - Brightness Down

F3 - Brightness Up

F4 - Display Switching

F5 - Blank

F6 - Mute

F7 - Volume Down

F8 -Volume Up

F9 - Previous

F10 - Play/Pause

F11 - Next

F12 - Airplane mode

SOFTWARE AND SECURITY

Preinstalled Software

HP JumpStarts

HP Documentation

HP Setup Integrated 00BE

SSRM is provided via SSRU/SSRD format, also can be download from Cloud. But it's not default preinstalled in image.

HP Audio Switch

HP Support Assistant²⁰

McAfee LiveSafe™

Security Management

TPM 2.0²¹

Security lock slot (Lock sold separately)

20. HP Support Assistant requires Windows and Internet access.

21. Firmware TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT). TPM is version 2.0. Hardware TPM is v1.2, which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).

POWER

Power Supply

HP Smart 65 W External AC power adapter^{22, 24}

HP Smart 65 W EM External AC power adapter^{22, 24}

HP Smart 45 W External AC power adapter²²

Primary Battery

HP Long Life 3-cell, 41 Wh Li-ion^{23,24}

Support battery fast charging - Approximately 90% in 90 minutes, Fast charge 50% in 45 mins

Power Cord

1M (3.28 feet) length power cord²²

Battery Life

Up to 12 hours and 30 minutes²⁵



Features

Battery Weight

0.18 kg 0.39 lb

- 22. Availability may vary by country.
- 23. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 24. Recharges the battery up to 90% within 90 minutes when the system is off or in standby mode. Power adapter with a minimum capacity of 65 watts is required. After charging has reached 90% capacity, charging will return to normal. Charging time may vary +/-10% due to System tolerance.
- 25. Windows 10 MM14 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight

Starting at 3.91 lb²⁶ Starting at 1.78 kg²⁶

Product Dimensions (w x d x h)

14.8 x 9.68 x 0.89 in 37.6 x 24.6 x 2.25 cm

26. Weight varies by configuration and components.

PORTS/SLOTS

Ports/Slots

2 USB 3.1 Gen 1

1 USB 2.0

1 HDMI v1.4b²⁷

1 RJ-45

1 AC power

1 Headphone/microphone combo jack

Expansion Slots

1 multi-format digital media reader Supports SD, SDHC, SDXC

27. HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers 1-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. Onsite service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go



Features

beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc .28

28. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



Technical Specifications

SYSTEM UNIT

Stand-Alone Power Requirements (AC

Power)

Nominal Operating Voltage 19.5 V Average Operating Power Win 10 Integrated graphics 6.39W

Discrete < 65W

Max Operating Power UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) (not writing optical)

41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%

Shock

Operating 40 G, 2 ms duration, half-sine Non-operating 240 G, 2 ms duration, half-sine

Random Vibration

Operating 1.043 grms
Non-operating 3.5 grms

Planned Industry Standard

Certifications

UL Yes CSA No FCC Compliance Yes ENERGY STAR® Yes 29

EPEAT® 2019 Yes, Silver in U.S.³⁰

ICES Yes Australia / Yes NZ A-Tick Compliance Yes CCC Yes Japan VCCI Compliance Yes KC Yes **BSMI** Yes **CE Marking Compliance** Yes **BNCI or BELUS** Yes CIT Yes Yes Saudi Arabian Compliance (ICCP) Yes **SABS** Yes



UKRSERTCOMPUTER

Yes

Technical Specifications

29. Configurations of the HP 250 G7 that are ENERGY STAR® certified are identified as HP 250 G7 ENERGY STAR on HP websites and on http://www.energystar.gov.

30. Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

15.6" diagonal HD WLED AntiGlare (1366x768) slim-flat (3.2mm) SVA, eDP

Outline Dimensions 360.0 x 224.3mm max

 $(W \times H \times D)$

Active Area 344.2 x 193.5 Weight 420 max. **Diagonal Size** 15.6 (inch) Thickness 3.2mm max Interface eDP 1.2 (1 lane) **Surface Treatment** Anti-glare (AG)

Touch Enabled NO

Contrast Ratio 300:1 (typ) **Refresh Rate** 60Hz **Brightness** 220 nit typ

Format 1366 x 768 (HD) **Pixel Resolution**

Configuration **RGB**

LED Backlight **Color Gamut Coverage** 45%

6 bits (Hi FRC) Color Depth Viewing Angle SVA 40/40/15/30

15.6" diagonal FHD WLED Outline Dimensions AntiGlare (1920x1080) slim-flat (3.2mm) SVA, eDP

360.0 x 224.3mm max

 $(W \times H \times D)$

Active Area 344.16 x 193.59 Weight 370g max. **Diagonal Size** 15.6 (inch) **Thickness** 3.2mm max Interface eDP 1.2 **Surface Treatment** Anti-glare (AG)

Touch Enabled NO

Contrast Ratio 300:1 (typ) **Refresh Rate** 60Hz **Brightness** 220 nit tvp

Pixel Resolution Format 1920 x 1080 (FHD)



Technical Specifications

Configuration RGB

Backlight LED 45% **Color Gamut Coverage**

Color Depth 6 bits + FRC **Viewing Angle** SVA 45/45/25/35

STORAGE AND DRIVES

500 GB 5400 rpm SATA **Dard Drive**

Drive Weight 92q(0.20lb) **Rotation speed** 5400 rpm **Cache Buffer** Up to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

69.85 +/- 0.25 mm (2.750 +/- 0.010 in) Width

Interface **ATA-8, SATA 3.0**

Transfer Rate 600 MB/s

Seek Time Single Track: 1.5 ms

> Average: 13 ms Maximum: 32 ms

Logical Blocks 976,773,168 **Operating Temperature** 0° to 60°C **Security Features ATA Security**

Features S.M.A.R.T., NCQ, Ultra DMA

500 GB 7200 rpm SATA **Hard Drive**

Drive Weight 92q(0.20lb) **Rotation speed** 7200 rpm **Cache Buffer** Up to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

69.85 +/- 0.25 mm (2.750 +/- 0.010 in) Width

Interface **ATA-8, SATA 3.0**

Transfer Rate 600 MB/s

Seek Time Single Track: 1.5 ms

> Average: 13 ms Maximum: 32 ms

Logical Blocks 976,773,168 0° to 60°C **Operating Temperature Security Features ATA Security**

Features S.M.A.R.T., NCQ, Ultra DMA

Technical Specifications

1 TB 5400 rpm SATA Hard Drive Weight 92g(0.20lb)

Drive Rotation speed 5400 rpm

Cache Buffer Up to 128MB

Height 7.0 +/- 0.2 mm (0.28 +/-.008 in)

Width 69.85 +/- 0.25 mm (2.750 +/- 0.010 in)

Interface ATA-8, SATA 3.0

Transfer Rate 600 MB/s

Seek Time Single Track: 1.5 ms

Average: 13 ms Maximum: 32ms

Logical Blocks1,953,525,168Operating Temperature0° to 60°CSecurity FeaturesATA Security

Features S.M.A.R.T., NCQ, Ultra DMA

128 GB 2280 M2 SATA-3 TLC Solid State Drive

 Drive Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate 550MB/s **Logical Blocks** 250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security

Features DIPM; TRIM; DEVSLP

256 GB 2280 M2 SATA-3 TLC Solid State Drive
 Drive Weight
 0.02 lb (10 g)

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Transfer Rate 550MB/s **Logical Blocks** 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Security Features ATA Security

Features DIPM; TRIM; DEVSLP



Technical Specifications

| 256 GB 2280 M2 PCIe | |
|-----------------------------|----|
| NVMe Value Solid Sta | te |
| Drive | |

Form Factor M.2 2280 Capacity 256 GB **NAND Type** TLC

0.09 in (2.3 mm) Height Width 0.87 in (22 mm)

Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Interface PCIe NVMe Gen3x2 **Maximum Sequential** Up To 1500 MB/s

Read

Maximum Sequential

Write

Up To 900 MB/s

Logical Blocks 500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

512 GB 2280 M2 PCIe **NVMe Value Solid State** Drive

Form Factor M.2 2280 Capacity 512 GB **NAND Type** TLC

Height 0.09 in (2.3 mm) Width 0.87 in (22 mm) PCIe NVMe Gen3x2 Interface **Maximum Sequential Up To 1600 MB/s**

Read

Maximum Sequential

Write

Up To 1000 MB/s

Logical Blocks 1,000,236,384

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM; L1.2

16 GB Intel® Optane™ Solution PCIe Gen3x2 M.2 Capacity SSD

Form Factor M.2 2280 16 GB **NAND Type** 3D Xpoint Height 0.09 in (2.3 mm) Width

0.87 in (22 mm) Interface PCIe NVMe Gen3x2

Technical Specifications

Maximum Sequential

Read

Maximum Sequential

Write

290MB/s

1350MB/s

Logical Blocks 31,257,387

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8822BE 802.11 ac 2x2 Wi-Fi® + Bluetooth® 4.2 Combo Adapter (MU-MIMO supported)¹ Wireless LAN Standards IEEE 802.11a

IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac

Interoperability Wi-Fi CERTIFIED™

Frequency Band 802.11b/g/n

•2.402 - 2.482 GHz

802.11a/n

•4.9 – 4.95 GHz (Japan) •5.15 – 5.25 GHz •5.25 – 5.35 GHz •5.47 – 5.725 GHz •5.825 – 5.850 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
 802.11n: MCS 0 ~ MCS 15. (20MHz, and 40MHz)

 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

8UMUZ)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³

IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

• IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Ad-hoc (Peer to Peer)

Models

Infrastructure (Access Point Required)

Roaming

IEEE 802.11 compliant roaming between access points

Technical Specifications

Output Power² • 802.11b: +14dBm minimum

802.11g: +12dBm minimum
802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
 802.11n HT40(2.4GHz): +12dBm minimum

• 802.11n HT20(5GHz): +10dBm minimum

• 802.11n HT40(5GHz): +10dBm minimum

802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption Transmit: 2.0 W (max)

Receive: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)
Connect Standby: 10 mW (WLAN+BT)

Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED White - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology



Technical Specifications

Bluetooth Specification 4.0/4.1/4.2 Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate¹ up to 2.17 Mbps

BLE: 1 Mbps data signaling data rate¹ up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with

a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTL8821CE 802.11ac 1x1 Wi-Fi® + Bluetooth® 4.2 Combo (MU-MIMO supported)¹ Wireless LAN Standards IEEE 802.11a

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac

Interoperability Wi-Fi CERTIFIED™ **Frequency Band** 802.11b/g/n

•2.402 - 2.482 GHz

802.11a/n

4.9 – 4.95 GHz (Japan)
5.15 – 5.25 GHz
5.25 – 5.35 GHz
5.47 – 5.725 GHz
5.825 – 5.850 GHz

Data Rates • 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

002.11.... MCCO MCCO /1CC and 3CC) /20MI- 40M

802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

• IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only



Technical Specifications

AES-CCMP: 128 bit in hardware

802.1x authentication

WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

Cisco Certified Extensions, all versions through CCX4 and CCX Lite

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming IEEE 802.11 compliant roaming between access points

Output Power² • 802.11b: +14dBm minimum

• 802.11g: +12dBm minimum

• 802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum
 802.11n HT40(2.4GHz): +12dBm minimum

802.11n HT20(5GHz): +10dBm minimum

• 802.11n HT40(5GHz): +10dBm minimum

802.11ac VHT80(5GHz): +10dBm minimum"

Power Consumption Transmit: 2.0 W (max)

Receive mode: 1.6 W (max)

Idle mode (PSP): 180 mW (WLAN Associated)
Idle mode: 50 mW (WLAN unassociated)

Connect Standby: 10 mW Radio disabled: 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

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 Weight
 Type 2230: 2.8g

 Operating Voltage
 3.3v +/- 9%

Temperature Operating 14° to 158° F (–10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)



Technical Specifications

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF

LED White - Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH) **Channels** BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps data signaling data rate¹ up to 2.17 Mbps

BLE: 1 Mbps data signaling data rate¹ up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

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asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

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3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® and Bluetooth® 5.01

Wireless LAN Standards IEEE 802.11a

IEEE 802.11b

IEEE 802.11q

IEEE 802.11n

IEEE 802.11ac

IEEE 802.11d

IEEE 802.11e

IEEE 802.11h

IEEE 802.11i

IEEE 802.11k

IEEE 802.11r

IEEE 802.11v

Interoperability Wi-Fi CERTIFIED™

Frequency Band •802.11b/g/n

2.402 – 2.482 GHz

•802.11a/n/ac

4.9 – 4.95 GHz (Japan)



Technical Specifications

5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz

Data Rates •802.11b: 1, 2, 5.5, 11 Mbps

•802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)

•802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, 80MHz & 160MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security³ •IEEE compliant 64 / 128 bit WEP encryption for a/b/q mode only

•AES-CCMP: 128 bit in hardware

•802.1x authentication

•WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

IEEE 802.11 compliant roaming between access points

WPA2 certificationIEEE 802.11iWAPI

Network Architecture

Models

Roaming

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Output Power² • 802.11b: +18.5dBm minimum

• 802.11g: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum
802.11ac VHT80(5GHz): +11.5dBm minimum
802.11ac VHT160(5GHz): +11.5dBm minimum

Power Consumption •Transmit mode 2.0 W

•Receive mode 1.6 W

Idle mode (PSP) 180 mW (WLAN Associated)
Idle mode 50 mW (WLAN unassociated)
Connected Standby/Modern Standby: 10mW

•Radio disabled 8 mW

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity⁴ 802.11b, 1Mbps: -93.5dBm maximum

802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum 802.11ac, MCS0: -84dBm maximum

Technical Specifications

802.11ac, MCS9: -59dBm maximum

Antenna type High efficiency antenna with spatial diversity, mounted in the display

enclosure

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Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Type 1216: 1.67 x 12.0 x 16.0 mm

Weight Type 2230: 2.8 g

Type 126: 1.3 g

Operating Voltage 3.3v +/- 9%

Temperature Operating: 14° to 158° F (–10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

Humidity Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Altitude Operating: 0 to 10,000 ft (3,048 m)

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LED Activity LED Amber – Radio OFF

LED OFF - Radio ON

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Bluetooth Specification 4.0/4.1/4.2/5.0 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps Signaling Data Rate 2.17 Mbps

BLE: 1 Mbps Signaling Data Rate 0.2 Mbps

1. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

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Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps

asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 4 dBm for BR and EDR.

Power Consumption Peak (Tx) 330 mW

Peak (Rx) 230 mW

Selective Suspend 17 mW

Electrical Interface USB 2.0 compliant

Bluetooth Software

Supported Link Topology Microsoft Windows Bluetooth Software



Technical Specifications

Power Management Microsoft Windows ACPI, and USB Bus Support **Certifications** FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power ManagementETS 300 328, ETS 300 826CertificationsLow Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported

BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 –Link Layer Privacy

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited.
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Technical Specifications

Wireless LAN Standards Realtek RTL8822CE IEEE 802.11a 802.11ac 2x2 Wi-Fi + BT5 IEEE 802.11b IEEE 802.11q IEEE 802.11n IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k IEEE 802.11r IEEE 802.11v Wi-Fi® certified Interoperability **Frequency Band** •802.11b/q/n 2.402 - 2.482 GHz •802.11a/n/ac 4.9 - 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz **Data Rates** • 802.11b: 1, 2, 5.5, 11 Mbps • 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps • 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz & 80MHz) Modulation **Direct Sequence Spread Spectrum** BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM Security³ •IEEE compliant 64 / 128 bit WEP encryption for a/b/g mode only •AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification •IEEE 802.11i •WAPI **Network Architecture** Ad-hoc (Peer to Peer) Models Infrastructure (Access Point Required) Roaming IEEE 802.11 compliant roaming between access points Output Power² • 802.11b: +18.5dBm minimum • 802.11q: +17.5dBm minimum • 802.11a: +18.5dBm minimum

802.11n HT20(2.4GHz): +15.5dBm minimum
802.11n HT40(2.4GHz): +14.5dBm minimum
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Technical Specifications

802.11ac VHT80(5GHz): +11.5dBm minimum
 802.11ac VHT160(5GHz): +11.5dBm minimum

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Idle mode (PSP) 180 mW (WLAN Associated)
 Idle mode 50 mW (WLAN unassociated)
 Connected Standby/Modern Standby: 10mW

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asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

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Selective Suspend 17 mW

Electrical Interface USB 2.0 compliant

Bluetooth Software

Supported Link Topology Microsoft Windows Bluetooth Software

Power Management Microsoft Windows ACPI, and USB Bus Support

Certifications FCC (47 CFR) Part 15C, Section 15.247 & 15.249

Power Management Certifications ETS 300 328, ETS 300 826 Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles
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Train Nudging & Interlaced Scan

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Technical Specifications

- 3. Check latest software/driver release for updates on supported security features.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

| Rea | ltek | Eth | ıerı | net |
|------|------|-----|------|-----|
| (10/ | 100 | /10 | 00 |) |

Ethernet Features 10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14)

100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40)

Auto-Negotiation (Automatic Speed Selection)

Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100

Mbit/s

IEEE 802.1p QoS (Quality of Service) Support

IEEE 802.1q VLAN support

IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)

IEEE 802.3az EEE (Energy Efficient Ethernet)

Jumbo Frame 9K

Auto MDI/MDIX Crossover cable detection

Power Management ACPI compliant - multiple power modes

Situation-sensitive features reduce power consumption

Advanced link down power saving for reducing link down power

consumption

Performance Features TCP/IP/UDP Checksum Offload (configurable)

Protocol Offload (ARP & NS)

Large send offload and Giant send offload

Receiving Side Scaling

Manageability Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft

Wake-Up Frame); Wake-on-LAN from off (Magic Packet only)

PXE 2.1 Remote Boot

Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x,

clause 30))

Comprehensive diagnostic and configuration software suite

Virtual Cable Doctor for Ethernet cable status

Interface PCI Express 1.1 to support ASPM L1

NIC Device Driver Name Realtek PCIe GBE Ethernet Family Controller

POWER

HP 65 W Smart AC adapter **Dimensions** $(H \times W \times D)$

108 x 47 x 37.4 mm

Weight 250 g Input Input

Input 100 to 240 VAC

Input Efficiency 88.0 % at 115 VAC and 89.0 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.7 A at 90 VAC



Technical Specifications

Output **Output power** 65 W

DC output 19.5 V

Hold-up time 5ms at 115 Vac input

Output current limit The power supply shall limit the maximum

steady state output current to an average

current of 11 Amperes.

Connector 4.5 mm Barrel Type

Environmental Design Operating 32° to 95° F (0° to 35° C) temperature

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000 m

above sea level

Humidity The power supply shall withstand without

> degradation with 95% relative humidity, noncondensing, both operating and non-operating

EMI and Safety *CE Mark - full compliance with LVD and EMC directives

Certifications * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B. CISPR22 Class B. CCC. NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

Dimensions $(H \times W \times D)$ 45 W AC adapter 95 x 40 x 26.5 mm

> Weight 200 q Input Input 100 to 240 VAC

> > **Input Efficiency** 87.8 % at 115 VAC and 88.5 % at 230VAC

Input frequency range 50~ 60 Hz

Input AC current Max. 1.4 A at 90 VAC

Output 45 W **Output power**

DC output 19.5 V

Hold-up time 5 ms at 115 Vac input

Output current limit The power supply shall limit the maximum

steady state output current to an average

current of 8 Amperes.

Connector 4.5 mm Barrel Type,

Environmental Design Operating 32° to 95° F (0° to 35° C) temperature

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000 m

above sea level

Humidity The power supply shall withstand without

degradation with 95% relative humidity, noncondensing, both operating and non-operating.

EMI and Safety *CE Mark - full compliance with LVD and EMC directives

Certifications * Worldwide safety standards - IEC60950, EN60950, UL60950, Class1,

SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC



Technical Specifications

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 65W Smart AC adapter (EM) **Dimensions** ($H \times W \times D$)

102 x 55 x 30 mm

Weight Input 270 g

Input

100 to 240 VAC

Input Efficiency

 $88.0\,\%$ at 115 VAC and $89.0\,\%$ at 230VAC

Input frequency range

50~ 60 Hz

Input AC current

Max. 1.7 A at 90 VAC

Output

Output power 65 W DC output 19.5 V

Hold-up time

5ms at 115 Vac input

Output current limit

The power supply shall limit the maximum steady state output current to an average

current of 11 Amperes.

Connector

Environmental Design

4.5 mm Barrel Type
Operating

temperature

32° to 95° F (0° to 35° C)

Non-operating (storage)

temperature

-4° to 185° F (-20° to 85° C)

Altitude The power supply can be operated at 5,000 m

above sea level

Humidity

The power supply shall withstand without degradation with 95% relative humidity, non-condensing, both operating and non-operating.

, idensing, both operating

EMI and Safety Certifications *CE Mark - full compliance with LVD and EMC directives

* Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC

Class B, CISPR22 Class B, CCC, NOM-1 NYCE.

* MTBF - over 200,000 hours at 25°C ambient condition.

HP 3-cell Li-Ion Long Life - Fast Charge (41 WHr) **Dimensions** $(H \times W \times L)$

6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

Weight

0.18 kg (0.39 lb)

Cells/Type

3cell Lithium-Ion Polymer cell / 515974

Voltage Amp-hour capacity 11.4V/11.34V

Watt-hour capacity

3.6Ah/3.62Ah 41Wh

Operating (Charging)
Operating (Discharging)

32° to 113° F (0° to 45° C) 14° to 122° F (-10° to 60° C)

Optional Travel Battery

Available

No

Dimensions 6.0 x 186.85 x 90.2 mm (0.236 x 7.35 x 3.55 inch)

Weight 0.19 kg (0.41 lb)

Technical Specifications

(41 WHr)

Cells/Type 3cell Lithium-Ion Prismatic cell / 496080

Voltage 11.55V

Amp-hour capacity 3.615Ah/3.63Ah

HP 3-cell Li-lon Watt-hour capacity 41Wh
Long Life - Fast Charge Operating (Charging) 32° to

Operating (Charging) 32° to 113° F (0° to 45° C)
Operating (Discharging) 14° to 122° F (-10° to 60° C)

Optional Travel Battery No

Available



Technical Specifications

Country of Origin

China



| Category Docking | Description HP Monitor Stand | Part Number M9X76AA |
|---------------------|----------------------------------------------------|-------------------------------|
| Input / Output | HP Slim Wireless Keyboard and Mouse | T6L04AA |
| | HP 3-Button USB Laser Mouse | H4B81AA |
| | HP USB Travel Mouse | G1K28AA |
| | HP Comfort Grip Wireless Mouse | H2L63AA |
| | HP Ultra Mobile Wireless Mouse | H6F25AA#xxx |
| | HP HDMI to DVI Adapter | F5A28AA |
| | HP Stereo USB Headset | T1A67AA |
| | HP Stereo 3.5mm Headset | T1A66AA |
| Power | HP 45W Smart AC Adapter 4.5mm | H6Y88AA#XXX |
| | HP 65W Smart AC Adapter | H6Y89AA#xxx |
| | HP 65W Slim AC Adapter | H6Y82AA#xxx |
| Storage | HP External USB Optical Drive | F2B56AA |
| Memory | HP 4GB 2666Mhz DDR4 | 4VN05AA |
| | HP 8GB 2666Mhz DDR4 | 4VN06AA |
| Displays | HP EliteDisplay S14 14-inch USB-C Portable Monitor | ЗНХ46АА |



Summary of Changes

| Date of change: | Version History: | | Description of change: |
|------------------|------------------|---------|----------------------------------------------------------------------------------------------------|
| | From v1 to v2 | | Accessories section |
| | From v2 to v3 | | Networking section |
| November 4, 2020 | From v3 to v4 | Updated | Removed - Intel® Iris® X® Graphics from processor name and added Iris footnote in graphics section |
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